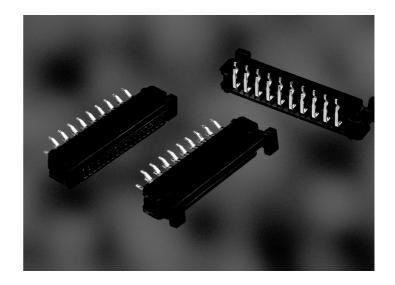
SLW series - ZIF / Through hole



1.00 mm Spacing for FFC / FPC / CIC

Features

- Available in 4 to 30 positions
- Right angle or vertical type
- Excellent cable retention with small size slider
- Kinked solder tails available



Benefits

- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Zero Insertion Force connection allows an increased number of mating cycles with minimal wear.
- The ZIF pre-holding process provides a stable and reliable mating operation.
- The slider ensures maximum cable retention with a minimum size.
- Fork shaped contacts mean stable and low contact resistance.
- Kinked solder tails provide added PCB retention.
- Product variations cover a broad range of applications.

Technical Data

PC Board pattern (component side)

Material

Housing:

Nylon, glass reinforced, UL94V-0, Black

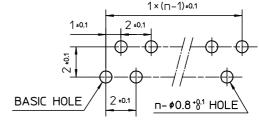
Slider

Nylon, glass reinforced, UL94V-0, Black

(For CIC: Milky-White)

Contact :

Phosphor Bronze, Tin alloy plated



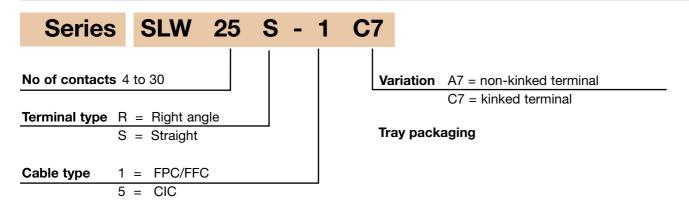
THICKNESS: 0.8~16

SLW series - ZIF / Through hole

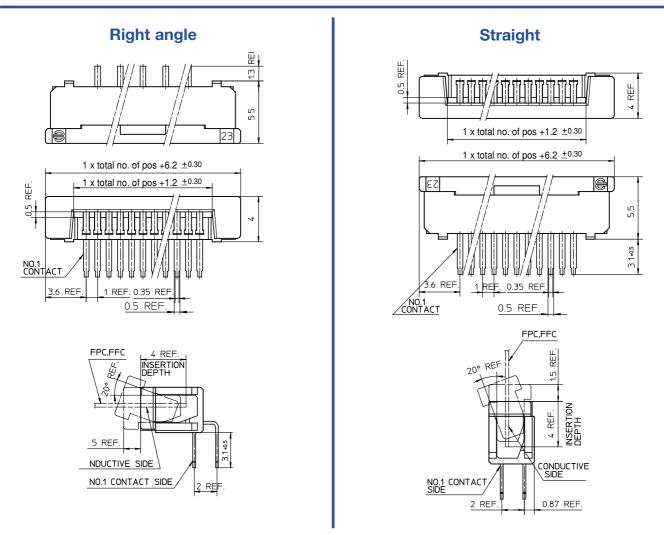


1.00 mm Spacing for FFC / FPC / CIC

Ordering Data



Dimensions



Circuitry Type For Recommended Circuitry type see page 31